

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Daijiro HARADA</td> <td>10/27/2011</td> </tr> <tr> <td>Takashi UTSUMI</td> <td>10/27/2011</td> </tr> </tbody> </table>		Name	Execution Date	Daijiro HARADA	10/27/2011	Takashi UTSUMI	10/27/2011
Name	Execution Date						
Daijiro HARADA	10/27/2011						
Takashi UTSUMI	10/27/2011						
RECEIVING PARTY DATA							
Name:	RENESAS ELECTRONICS CORPORATION						
Street Address:	1753, Shimonumabe, Nakahara-ku						
City:	Kawasaki-shi, Kanagawa						
State/Country:	JAPAN						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13331923</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13331923		
Property Type	Number						
Application Number:	13331923						
CORRESPONDENCE DATA							
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NAME OF SUBMITTER:	Sahar A. Ahmed, New Apps Specialist						
Total Attachments: 1 source=ASSIGNMENT_EXECUTED#page1.tif							

OP \$40.00 13331923

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Electronics Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Daijiro Harada Daijiro HARADA

October 27, 2011

2) Takashi Utsumi Takashi UTSUMI

October 27, 2011

3) _____

4) _____

5) _____

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10) _____
